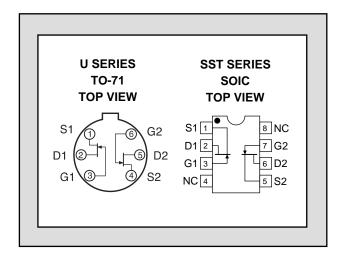


Twenty-Five Years Of Quality Through Innovation

FEATURES						
Direct Replacement for SILICONIX U/SST440 & U/SST441						
HIGH CMRR ≥ 850						
LOW GATE LEAKAGE	I _{GSS} ≤ 1pA					
ABSOLUTE MAXIMUM RATINGS ¹						
@ 25 °C (unless otherwise stated)						
Maximum Temperatures						
Storage Temperature	-55 to +150 °C					
Operating Junction Temperature	-55 to +150 °C					
Maximum Power Dissipation @ TA = 25°C						
Continuous Power Dissipation (Total)	500mW					
Maximum Currents						
Gate Current	50mA					
Maximum Voltages						
Gate to Drain	-25V					
Gate to Source	-25V					
Gate to Gate	±50V					

U/SST440, 441

WIDEBAND HIGH GAIN MONOLITHIC DUAL N-CHANNEL JFET AMPLIFIER



MATCHING CHARACTERISTICS @ 25 °C (unless otherwise stated)

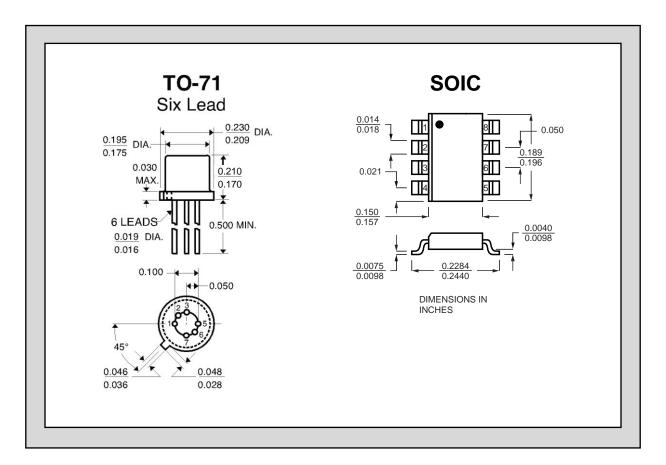
SYMBOL	CHARACTERISTIC		MIN	TYP	MAX	UNITS	CONDITIONS
VGS1 — VGS2	Differential Gate to Source Cutoff Voltage	U/SST440			10	mV	$V_{DG} = 10V$, $I_D = 5mA$
		U/SST441			20		
$\frac{\Delta \left V_{\text{GS1}}-V_{\text{GS2}}\right }{\Delta T}$	Differential Gate to Source Cutoff Voltage Change with Temperature			20		μV/°C	$V_{DG} = 10V, I_D = 5mA$ $T_A = -55 \text{ to } +125^{\circ}\text{C}$
	Gate to Source Saturation Current Ratio ³			0.98			$V_{DS} = 10V, V_{GS} = 0V$
$\frac{g_{\text{fs1}}}{g_{\text{fs2}}}$	Forward Transconductance Ratio ²			0.97			$V_{DS} = 10V, I_{D} = 5mA, f = 1kHz$
CMRR	Common Mode Rejection Ratio			85		dB	$V_{DG} = 5$ to 10V, $I_D = 5$ mA

ELECTRICAL CHARACTERISTICS @ 25 °C (unless otherwise stated)

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	CONDITIONS
BV _{GSS}	Gate to Source Breakdown Voltage	-25			V	$I_G = -1\mu A$, $V_{DS} = 0V$
V _{GS(off)}	Gate to Source Cutoff Voltage	-1	-3.5	-6	V	$V_{DS} = 10V, I_{D} = 1nA$
IDSS	Gate to Source Saturation Current ²	6	15	30	mA	$V_{DS} = 10V$, $V_{GS} = 0V$
I_{GSS}	Gate Leakage Current		-1	-500	n ^	$V_{GS} = -15V$, $V_{DS} = 0V$
lg	Gate Operating Current		-1	-500	рA	$V_{DG} = 10V, I_D = 5mA$

ELECTRICAL CHARACTERISTICS CONTINUED @ 25 °C (unless otherwise stated)

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	CONDITIONS
g fs	Forward Transconductance	4.5	6	9	mS	$V_{DS} = 10V, I_{D} = 5mA, f = 1kHz$
gos	Output Conductance		70	200	μS	
Ciss	Input Capacitance		3		۰,۲	$V_{DS} = 10V, I_D = 5mA, f = 1MHz$
Crss	Reverse Transfer Capacitance		1		pF	
en	Equivalent Input Noise Voltage		4		nV/√Hz	$V_{DS} = 10V, I_D = 5mA, f = 10kHz$



NOTES:

- 1. Absolute maximum ratings are limiting values above which serviceability may be impaired.
- 2. Pulse Test: PW ≤ 300µs Duty Cycle ≤ 3%
- 3. Assumes smaller value in numerator.

Information furnished by Linear Integrated Systems is believed to be accurate and reliable. However, no responsibility is assumed for its use; nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Linear Integrated Systems.

Linear Integrated Systems (LIS) is a 25-year-old, third-generation precision semiconductor company providing high-quality discrete components. Expertise brought to LIS is based on processes and products developed at Amelco, Union Carbide, Intersil and Micro Power Systems by company President John H. Hall. Hall, a protégé of Silicon Valley legend Dr. Jean Hoerni, was the director of IC Development at Union Carbide, Co-Founder and Vice President of R&D at Intersil, and Founder/President of Micro Power Systems.